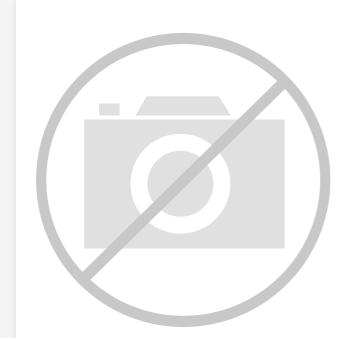
# Renesas Electronics America Inc - <u>IDT79RC64T574-200DZ Datasheet</u>



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#### **Understanding Embedded - Microprocessors**

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

#### Applications of **Embedded - Microprocessors**

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

#### Details

Product Status	Obsolete
Core Processor	MIPS-I
Number of Cores/Bus Width	1 Core, 64-Bit
Speed	200MHz
Co-Processors/DSP	System Control; CP0
RAM Controllers	SDRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	-
SATA	-
USB	-
Voltage - I/O	2.5V, 3.3V
Operating Temperature	0°C ~ 85°C (TC)
Security Features	-
Package / Case	128-BQFP Exposed Pad
Supplier Device Package	128-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/idt79rc64t574-200dz

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

### **Device Overview<sup>1</sup>**

IDT's 79RC64574/575 processors serve a wide range of performance-critical embedded applications that include high-end internetworking systems, digital set-top boxes, web browsers, color printers, and graphics terminals.

The RC64574/575 allow a socket compatible upgrade path for IDT's RC4640/50 and RC64474/475 processors. This unprecedented upgradability allows a 2:1 range of frequencies; 4:1 range of cache size; 15:1 range of floating-point; and 4:1 range of DSP performance in a single socket.

With special emphasis on system bandwidth, floating- point and DSP operations, the RC64574/575 have been optimized for high-performance applications through the integration of high-performance computational units and a high-performance memory hierarchy. The result is a low-cost CPU that is capable of more than 330 Dhrystone MIPS. Through the RC64574/64575 processors IDT offers:

- High-performance upgrade paths to existing embedded customers in the internetworking, office automation and visualization markets.
- Significant floating-point performance improvements over currently available, moderately priced MIPS CPUs.
- Performance improvements through the use of the MIPS-IV ISA.
- High-performance DSP acceleration

### **Instruction Issue Mechanism**

The RC64574 and RC64575 are limited dual-issue super-scalar machines that use a traditional 5-stage integer pipeline, as shown in the pipeline diagram on Page 3. For multi-issue operations, these devices recognize the following two general classes of instructions:

- Floating-point ALU
- All others

Such a broad separation of instruction classes insure that there are no data dependencies to restrict multi-issue performance. As they are brought on-chip, these instruction classes are pre-decoded by the RC64574/575, and the class information is then stored in the instruction cache. Assuming there are no pending resource conflicts, the devices can issue one instruction per class per pipeline clock cycle.

However, longer latency resources—in either the floating-point ALU (for example, division or square root instructions) or integer unit (such as multiply)—can restrict the issue of instructions. Note that these processors do not perform out-of-order or speculative execution; instead, the pipeline slips until the required resource becomes available.

On dual-issue instruction pairs, there are no alignment restrictions, and the RC64574/575 fetch two instructions from the cache per cycle. Thus, for optimal performance, compilers should attempt to align branch targets to allow dual-issue on the first target cycle, because the instruction cache only performs aligned fetches.

#### **RISCore4000/RISCore5000 Family of Socket Compatible Processors**

	32-bit E	xternal Bus Pro	ocessors	64-bit External Bus Processors			
	RC4640	RC64474	RC64574	RC4650	RC64475	RC64575	
CPU	64-bit RISCore4000 w/ DSP extensions	64-bit RISCore4000	64-bit RISCore5000 w/ DSP extensions	64-bit RISCore4000 w/ DSP extensions	64-bit RISCore4000	64-bit RISCore5000 w/ DSP extensions	
Performance	>350MIPS	>330MIPS	>330MIPS	>350MIPS	>330MIPS	>330MIPS	
FPA	89 mflops, single preci- sion only 125 mflops, single and double precision		666 mflops, single and double precision	89 mflops, single preci- sion only	125 mflops, single and double precision	666 mflops, single and double precision	
Caches	8kB/8kB, 2-way, lockable by set	16kB/16kB, 2-way, lockable by set	32kB/32kB, 2-way, lockable by line	8kB/8kB, 2-way, lockable by set	16kB/16kB, 2-way, lockable by set	32kB/32kB, 2-way, lockable by line	
External Bus	32-bit	32-bit, Superset pin compatible w/RC4640	32-bit, Superset pin compatible w/RC4640, RC64474	32- or 64-bit	32-or 64-bit, Superset pin compatible w/ RC4650	32-or 64-bit, Superset pin compatible w/ RC4650, RC64475	
Voltage	3.3V	3.3V	2.5V	3.3V	3.3V	2.5V	
Frequencies	100-267 MHz	180-250 MHz	200-250 MHz	100-267 MHz	180-250 MHz	250 MHz	
Packages	128 PQFP	128 QFP	128 QFP	208 QFP	208 QFP	208 QFP	
MMU	Base-Bounds 96 page TLB		96 page TLB	Base-Bounds	96 page TLB	96 page TLB	
Key Features	Cache locking, on-chip MAC, 32-bit external bus	Cache locking, JTAG, syncDRAM mode, 32-bit external bus	Cache locking, JTAG, syncDRAM mode, 32-bit external bus	Cache locking, on-chip MAC, 32-bit & 64 bit bus option	Cache locking, JTAG, syncDRAM mode, 32- 64- bit bus option	Cache locking, JTAG, syncDRAM mode, 32- 64- bit bus option	

Table 1 RISCore4000/RISCore5000 Processor Family

<sup>&</sup>lt;sup>1.</sup> Detailed system operation information is provided in the RC64574/RC64575 user's manual.

### **Instruction Set Architecture**

The RC64574/575 implement a superset of the MIPS-IV 64-bit ISA, including CP1 and CP1X functional units and their instruction set. Both 32- and 64-bit data operations are performed by utilizing thirty-two general purpose 64-bit registers (GPR) that are used for integer operations and address calculation. The complete on-chip floating-point coprocessor (CP1)—which includes a floating-point register file and execution units—forms a "seamless" interface, decoding and executing instructions in parallel with the integer unit.

**CP1's floating-point execution units** support both single and double precision arithmetic—as specified in the IEEE Standard 754—and are separated into a multiply unit and a combined add/convert/ divide/square root unit. Overlap of multiplies and add/subtract is supported, and the multiplier is partially pipelined, allowing the initiation of a new multiply instruction every fourth pipeline cycle. The **floating-point register file** is made up of thirty-two 64-bit registers. The floating-point unit can take advantage of the 64-bit wide data cache and issue a co-processor load or store doubleword instruction in every cycle.

The **system control coprocessor (CP0) registers** are also incorporated on-chip and provide the path through which the virtual memory system's page mapping is examined and changed, exceptions are handled, and any operating mode selections are controlled. A secure user processing environment is provided through the **user, supervisor, and kernel operating modes** of virtual addressing to system software. Bits in a status register determine which of these modes is used.

### **Integer Pipeline**

Operation	Latency	Repeat
Load	2	1
Store	2	1
MULT/MULTU	4	3
DMULT/DMULTU	6	5
DIV/DIVU	36	36
DDIV/DDIVU	68	68
MAD/MADU	3	2
MSUB/MSUBU	4	3
Other Integer ALU	1	1
Branch	2	2
Jump	2	2

The integer instruction execution speed is tabulated—in number of pipeline clocks—as follows:

#### Table 2 Integer Instruction Execution Speed

To insure that the maximum frequency of operation is not limited by the speed of the multiplier unit, a **"fast multiply"** disable reset mode bit (see Table 2) is featured. When this bit is asserted, each multiply operation shown in Table 1 has its latency and repeat rate increased by one cycle. Load and branch latencies are minimized by the short pipeline of the RC64574/575, and the caches contain special logic that will allow any combination of loads and stores to execute in back-to-back cycles without requiring pipeline slips or stalls, assuming the operation does not miss in the cache.

### **Computational Units**

The RC64574/575 implement a full, single-cycle 64-bit arithmetic logic unit (ALU), for **Integer ALU** functions other than multiply and divide. Bypassing is used to support back-to-back ALU operations at the full pipeline rate, without requiring stalls for data dependencies.

To allow the longer latency operations to run in parallel with other operations, the **Integer Multiply/Divide** unit of the RC64574/575 is separated from the primary ALU. The pipeline stalls only if an attempt to access the HI or LO registers is made before an operation completes.

The **Floating-point ALU** unit is responsible for all of the CP1/CP1X ALU operations—other than DIV/SQRT operations—and is pipelined to allow a single-cycle repeat rate for single-precision operations.

The **Floating-point DIV/SQRT** unit is separated from the floatingpoint ALU, to ensure that these longer latency operations do not prevent the issue of other floating-point operations. Separate logical units are also provided on the RC64574/575 to implement load, store, and branch operations.

Intended to enhance the performance of DSP algorithms such as fast fused multiply-adds, multiply-subtracts and three operand multiply operations, **new instructions** have been added over and above the MIPS-IV ISA.

### **System Interfaces**

The **RC64575 supports a 64-bit system interface** that is pin and bus compatible with the RC4650 and RC64475 system interface. The system interface consists of a 64-bit Address/Data bus with eight parity-check bits and a 9-bit command bus.

During 64-bit operation, RC64575 system address/data (SysAD) transfers are protected with an 8-bit parity check bus, SysADC. When initialized for 32-bit operation, the RC64575's SysAD can be viewed as a 32-bit multiplexed bus that is protected by four parity-check bits.

The **RC64574 supports a 32-bit system interface** that is pin and bus compatible with the RC4640 and RC64474. During 32-bit operation, SysAD transfers are performed on a 32-bit multiplexed bus (SysAD 31:0) that is protected by 4 parity check bits (SysADC 6:0).

Writes to external memory—whether they are cache miss writebacks, stores to uncached or write-through addresses—use the on-chip **write buffer**. The write buffer holds a maximum of four 64-bit addresses and 64-bit data pairs. The entire buffer is used for a data cache writeback and allows the processor to proceed in parallel with memory updates.

Included in the system interface are **six handshake signals**: RdRdy\*, WrRdy\*, ExtRqst\*, Release\*, ValidOut\*, and ValidIn\*; **six interrupt inputs**, and a **simple timing** specification that is capable of trans-

Choosing a 32- or 64-bit wide system interface dictates whether a cache line block transaction requires 4 double word data cycles or 8 single word cycles as well as whether a single data transfer—larger than 4 bytes—must be divided into two smaller transfers.

As shown in Table 3, the bus delay can be defined as 0 to 7 SysClock cycles and is activated and controlled through mode bit (17:15) settings selected during the reset initialization sequence. The '000' setting provides the same write operations timing protocol as the RC4640, RC4650, and RC5000 processors.

To facilitate discrete **interface to SyncDRAM**, the RC64574/575 bus interface is enhanced during write cycles with a programmable delay that is inserted between the write address and the write data (for both block and non-block writes).

**Board-level testing** during Run-Time mode is facilitated through the full JTAG boundary scan facility. Five pins—TDI, TDO, TMS, TCK, TRST\*—have been incorporated to support the standard JTAG interface.

The RC64574/575 devices offer a direct migration path for designs that are based on IDT's RC4640/RC4650 and RC64474/RC64475 processors<sup>2</sup>, through full pin and socket compatibility. Full 64-bit-family software and bus protocol compatibility ensures the RC64574/575 processors access to an existing market and development infrastructure, allowing quicker time to market.

### **Development Tools**

An array of hardware and software tools is available to assist system designers in the rapid development of RC64574/575 based systems. This accessibility allows a wide variety of customers to take full advantage of the device's high-performance features while addressing today's aggressive time-to-market demands.

### **Cache Memory**

To keep the high-performance pipeline of the RC64574/575 full and operating efficiently, on-chip instruction and data caches have been incorporated. Each cache has its own data path and can be accessed in the same single pipeline clock cycle.

The 32kB two-way set associative **instruction cache** is virtually indexed, physically tagged, and word parity protected. Because this cache is virtually indexed, the virtual-to-physical address translation occurs in parallel with the cache access, further increasing performance by allowing both operations to occur simultaneously. The instruction cache provides a peak instruction bandwidth of 2GB/sec at 250MHz.

The 32kB two-way set associative **data cache** is byte parity protected and has a fixed 32-byte (eight words) line size. Its tag is protected with a single parity bit. To allow simultaneous address translation and data cache access, the D-cache is virtually indexed and physically tagged. The data cache can provide 8 bytes each clock cycle, for a peak bandwidth of 2GB/s.

<sup>2.</sup> To ensure socket compatibility, refer to Table 8 and Table 9.

To lock critical sections of code and/or data into the caches for quick access, a per line **"cache locking"** feature has been implemented. Once enabled, a cache is said to be locked when a particular piece of code or data is loaded into the cache and that cache location will not be selected later for refill by other data.

### **Power Management**

Executing the WAIT instruction enables the processor to enter Standby mode. The internal clocks will shut down, thus freezing the pipeline. The PLL, internal timer, and some of the input pins (Int[5:0]\*, NMI\*, ExtReq\*, Reset\*, and ColdReset\*) will continue to run. Once in Standby Mode, any interrupt, including the internally generated timer interrupt, will cause the CPU to exit Standby Mode.

### **Thermal Considerations**

The RC64574 is packaged in a 128-pin QFP footprint package and uses a 32-bit external bus, offering the ideal combination of 64-bit processing power and 32-bit low-cost memory systems. The RC64575 is packaged in a 208-pin QFP footprint package and uses the full 64-bit external bus. The RC64575 is ideal for applications requiring 64-bit performance and 64-bit external bandwidth.

Both devices are guaranteed in a case temperature range of  $0^{\circ}$  to +85° C for commercial temperature devices and -40° to +85° C for Industrial temperature devices. Package type, speed (power) of the device, and air flow conditions affect the equivalent ambient temperature conditions that will meet these specifications.

Using the thermal resistance from case to ambient ( $\emptyset$ CA) of the given package, the equivalent allowable ambient temperature, TA, can be calculated. The following equation relates ambient and case temperatures:

TA = TC - P \* ØCA

where P is the maximum power consumption at hot temperature, calculated by using the maximum Icc specification for the device. Typical values for  $\emptyset$ CA at various air flow are shown in Table 4. Note that the RC64574/575 processor implements advanced power management, which substantially reduces the typical power dissipation of the device.

	ØCA					
Airflow (ft/min)	0	200	400	600	800	1000
128 QFP	16	10	9	7	6	5
208 QFP	20	13	10	9	8	7

Table 4 Thermal Resistance (ØCA) at Various Airflows

### **Revision History**

July 22, 1999: Original data sheet.

## **Pin Description Table**

The following is a list of system interface pins available on the RC64574/575. Pin names ending with an asterisk (\*) are active when low.

Pin Name	Туре	Description
System Interface	1	
ExtRqst*	1	External request An external agent asserts ExtRqst* to request use of the System interface. The processor grants the request by asserting Release*.
Release*	0	Release interface In response to the assertion of ExtRqst* or a CPU read request, the processor asserts Release* and signals to the requesting device that the system interface is available.
RdRdy*	1	Read Ready The external agent asserts RdRdy* to indicate that it can accept a processor read request.
WrRdy*	1	Write Ready An external agent asserts WrRdy* when it can now accept a processor write request.
ValidIn*	1	Valid Input Signals that an external agent is now driving a valid address or data on the SysAD bus and a valid command or data identifier on the SysCmd bus.
ValidOut*	0	Valid Output           Signals that the processor is now driving a valid address or data on the SysAD bus and a valid command or data identifier on the SysCmd bus.
SysAD(63:0)	1/O	System address/data bus A 64-bit address and data bus for communication between the processor and an external agent. In 64 bit interface mode, during address phases only, SysAd(35:0) contains invalid address information. The remain- ing SysAD(63:36) pins are not used. The whole 64-bit SysAD(63:0) may be used during the data transfer phase. For all double-word accesses (read or write), the low-order 3 bits (SysAD[2:0]) will always be output as zero during the address phase. In 32-bit interface mode and in the RC64574, SysAD(63:32) is not used, regardless of Endianness. A 32-bit address and data communication between processor and external agent is performed via SysAD(31:0).
SysADC(7:0)	I/O	System address/data check bus An 8-bit bus containing parity check bits for the SysAD bus during data bus cycles. In 32-bit mode and in the RC64574, SysADC(7:4) is not used. The SysADC(3:0) contains check bits for SysAD(31:0).
SysCmd(8:0)	I/O	System command/data identifier bus A 9-bit bus for command and data identifier transmission between the processor and an external agent.
SysCmdP	I/O	System Command Parity A single, even-parity bit for the Syscmd bus. This signal is always driven low.
Clock/Control Interf	ace	
SysClock	1	<b>SystemClock</b> The system clock input establishes the processor and bus operating frequency. It is multiplied internally by 2.3.4.5.6.7, or 8 to generate the pipeline clock (PClock).

		2,3,4,5,6,7, or 8 to generate the pipeline clock (PClock).	
V <sub>cc</sub> P	I	Quiet VCC for PLL Quiet Vcc for the internal phase locked loop.	
V <sub>SS</sub> P	1	Quiet V <sub>ss</sub> for PLL Quiet Vss for the internal phase locked loop.	

 Table 5 Pin Descriptions (Page 1 of 2)

Pin Name	Туре	Description
Interrupt Interface	1	
Int*(5:0)	1	Interrupt Six general processor interrupts, bit-wise ORed with bits 5:0 of the interrupt register.
NMI*	I	Non-maskable interrupt Non-maskable interrupt, ORed with bit 6 of the interrupt register.
Initialization Interfac	e	
V <sub>CC</sub> ok	1	V <sub>cc</sub> is OK When asserted, this signal indicates to the processor that the power supply has been above the Vcc minimum for more than 100 milliseconds and will remain stable. The assertion of Vccok initiates the initialization sequence.
ColdReset*	I	Cold reset This signal must be asserted for a power on reset or a cold reset. ColdReset must be de-asserted synchro- nously with SysClock.
Reset*	1	Reset This signal must be asserted for any reset sequence. It can be asserted synchronously or asynchronously for a cold reset, or synchronously to initiate a warm reset. Reset must be de-asserted synchronously with SysClock.
ModeClock	0	Boot-mode clock Serial boot-mode data clock output at the system clock frequency divided by two hundred fifty-six.
Modeln	Ι	Boot-mode data in Serial boot-mode data input.
JTAG Interface	1	
TDI	I	JTAG Data In On the rising edge of TCK, serial input data are shifted into either the Instruction register or Data register, depending on the TAP controller state. An external pull-up resistor is required.
TDO	0	JTAG Data Out On the falling edge of TCK, the TDO is serial data shifted out from either the instruction or data register. When no data is shifted out, the TDO is tri-stated (high impedance).
ТСК	I	JTAG Clock Input An input test clock used to shift into or out of the boundary-scan register cells. TCK is independent of the sys- tem and processor clock with nominal 40-60% duty cycle.
TMS	I	JTAG Command Select The logic signal received at the TMS input is decoded by the TAP controller to control test operation. TMS is sampled on the rising edge of TCK. An external pull-up resistor is required.
TRST*	1	JTAG Reset The TRST* pin is an active-low signal used for asynchronous reset of the debug unit, independent of the pro- cessor logic. During normal CPU operation, the JTAG controller will be held in the reset mode, asserting this active low pin. When asserted low, this pin will also tristate the TDO pin. An external pull-down resistor is required.
JTAG32*	1	JTAG 32-bit scan This pin is used to control length of the scan chain for SysAD (32-bit or 64-bit) for the JTAG mode. When set to Vss, 32-bit bus mode is selected. In this mode, only SysAD(31:0) are part of the scan chain. When set to Vcc, 64-bit bus mode is selected. In this mode, SysAD(63:0) are part of the scan chain. This pin has a built-in pull-down device to guarantee 32-bit scan, if it is left un connected.
	1.	

 JR\_V<sub>cc</sub>
 I
 JTAG VCC

 This pin has an internal pull-down to continuously reset the JTAG controller (if left unconnected) bypassing the TRst\* pin. When supplied with Vcc, the TRst\* pin will be the primary control for the JTAG reset.

Table 5 Pin Descriptions (Page 2 of 2)

## RC64575 208-pin QFP Package Pin-out

Pin names followed by an asterisk (\*) are active when low. For maximum flexibility and compatibility with future designs, N.C. pins should be left floating.

Pin	Function	Pin	Function	Pin	Function	Pin	Function
1	N.C.	53	JTAG32*	105	N.C.	157	N.C.
2	N.C.	54	N.C.	106	N.C.	158	N.C.
3	N.C.	55	N.C.	107	N.C.	159	SysAD59
4	N.C.	56	N.C.	108	N.C.	160	ColdReset*
5	N.C.	57	SysCmd2	109	N.C.	161	SysAD28
6	N.C.	58	SysAD36	110	N.C.	162	V <sub>cc</sub>
7	N.C.	59	SysAD4	111	N.C.	163	V <sub>ss</sub>
8	N.C.	60	SysCmd1	112	N.C.	164	SysAD60
9	N.C.	61	V <sub>ss</sub>	113	N.C.	165	Reset*
10	SysAD11	62	V <sub>cc</sub>	114	SysAD52	166	SysAD29
11	V <sub>ss</sub>	63	SysAD35	115	ExtRqst*	167	SysAD61
12	V <sub>cc</sub>	64	SysAD3	116	V <sub>cc</sub>	168	SysAD30
13	SysCmd8	65	SysCmd0	117	V <sub>ss</sub>	169	V <sub>cc</sub>
14	SysAD42	66	SysAD34	118	SysAD21	170	V <sub>ss</sub>
15	SysAD10	67	V <sub>ss</sub>	119	SysAD53	171	SysAD62
16	SysCmd7	68	V <sub>cc</sub>	120	RdRdy*	172	SysAD31
17	V <sub>ss</sub>	69	SysAD2	121	Modein	173	SysAD63
18	V <sub>cc</sub>	70	Int5*	122	SysAD22	174	V <sub>cc</sub>
19	SysAD41	71	SysAD33	123	SysAD54	175	V <sub>ss</sub>
20	SysAD9	72	SysAD1	124	V <sub>cc</sub>	176	V <sub>cc</sub> OK
21	SysCmd6	73	V <sub>ss</sub>	125	V <sub>ss</sub>	177	SysADC3
22	SysAD40	74	V <sub>cc</sub>	126	Release*	178	SysADC7
23	V <sub>ss</sub>	75	Int4*	127	SysAD23	179	N.C.
24	V <sub>cc</sub>	76	SysAD32	128	SysAD55	180	TDI
25	SysAD8	77	SysAD0	129	NMI*	181	TRst*
26	SysCmd5	78	Int3*	130	V <sub>cc</sub>	182	ТСК
27	SysADC4	79	V <sub>ss</sub>	131	V <sub>ss</sub>	183	TMS
28	SysADC0	80	V <sub>cc</sub>	132	SysADC2	184	TDO
29	V <sub>ss</sub>	81	Int2*	133	SysADC6	185	V <sub>cc</sub> P
30	V <sub>cc</sub>	82	SysAD16	134	SysAD24	186	V <sub>ss</sub> P
31	SysCmd4	83	SysAD48	135	V <sub>cc</sub>	187	SysClock
32	SysAD39	84	Int1*	136	V <sub>ss</sub>	188	V <sub>cc</sub>
33	SysAD7	85	V <sub>ss</sub>	137	SysAD56	189	V <sub>ss</sub>

Table 6 RC64575 208-pin QFP Package Pin-Out (Page 1 of 2)

Pin	Function	Pin	Function	Pin	Function	Pin	Function
34	SysCmd3	86	V <sub>cc</sub>	138	SysAD25	190	SysADC5
35	V <sub>ss</sub>	87	SysAD17	139	SysAD57	191	SysADC1
36	V <sub>cc</sub>	88	SysAD49	140	V <sub>cc</sub>	192	V <sub>cc</sub>
37	SysAD38	89	Int0*	141	V <sub>ss</sub>	193	V <sub>ss</sub>
38	SysAD6	90	SysAD18	142	N.C	194	SysAD47
39	ModeClock	91	V <sub>ss</sub>	143	SysAD26	195	SysAD15
40	WrRdy*	92	V <sub>cc</sub>	144	SysAD58	196	SysAD46
41	SysAD37	93	SysAD50	145	N.C.	197	V <sub>cc</sub>
42	SysAD5	94	ValidIn*	146	V <sub>cc</sub>	198	V <sub>ss</sub>
43	V <sub>ss</sub>	95	SysAD19	147	V <sub>ss</sub>	199	SysAD14
44	V <sub>cc</sub>	96	SysAD51	148	SysAD27	200	SysAD45
45	N.C.	97	V <sub>ss</sub>	149	N.C.	201	SysAD13
46	N.C.	98	V <sub>cc</sub>	150	JR_V <sub>cc</sub>	202	SysAD44
47	N.C.	99	ValidOut*	151	N.C.	203	V <sub>ss</sub>
48	N.C.	100	SysAD20	152	N.C.	204	V <sub>cc</sub>
49	N.C.	101	N.C.	153	N.C.	205	SysAD12
50	N.C.	102	N.C.	154	N.C.	206	SysCmdP
51	N.C.	103	N.C.	155	N.C.	207	SysAD43
52	N.C.	104	N.C.	156	N.C.	208	N.C.

Table 6 RC64575 208-pin QFP Package Pin-Out (Page 2 of 2)

### RC64574 Socket Compatibility to RC64474 & RC4640

The RC64574/575 is 100% pin compatible with the RC64474/475 with the supply voltage being the only difference. RC64474/475 requires a 3.3V supply, while RC64574/575 requires a 2.5V supply.

To ensure socket compatibility between the RC64574/RC64474 and the RC4640 devices, several pin changes are required, as shown in the tables below. **Note:** The RC64574/575 are 2.5V parts and as such all Vcc must be at the correct voltage for a given part.

Pin	RC4640	RC64574/ RC64474	Compatible to RV4640?	Comments
1	N.C	JTAG32*	Yes	Pin has an internal pull-down, to enable 32-bit scan. Can also be left a N.C.
48	V <sub>ss</sub>	TDO	Yes	Can be driven with $V_{ss}, \mbox{ if JTAG} \mbox{ is not needed. Is tristated when TRst* is low.}$
49	V <sub>ss</sub>	TMS	Yes	Can be driven with $V_{ss}$ if JTAG is not needed.
50	V <sub>ss</sub>	ТСК	Yes	Can be driven with $V_{ss}$ if JTAG is not needed.
51	V <sub>ss</sub>	TRst*	Yes	Can be driven with $V_{ss}$ if JTAG is not needed.
52	V <sub>ss</sub>	TDI	Yes	Can be driven with $V_{ss}$ if JTAG is not needed.
71	N.C.	JR_V <sub>cc</sub>	Yes	Can be left N.C. in RC64574, if JTAG is not need. If JTAG is needed, it must be driven to $\rm V_{cc}.$

Table 8 RC64574 Socket Compatibility to RC64474 and R4640

## RC64575 Socket Compatibility to RC64475 & RC4650

Pin	RV4650 32-bit	RC64575 32-bit RC64475 32-bit	RV4650 64-bit	RC64575 64-bit RC64475 64-bit	Compatible to RV4650?	Comments
53	N.C.	JTAG32*	No Connect	JTAG32*	Yes	In 32-bit, this pin can be left unconnected because of internal pull-down. In 64-bit, this assumes that JTAG will not be used. If using JTAG, this pin must be at $V_{cc}$ .
150	N.C.	JR_V <sub>cc</sub>	No Connect	JR_V <sub>cc</sub>	Yes	In RC64475, can be left a N.C, if JTAG is not need. If JTAG is needed, it must be driven to $V_{cc}$ .
180	N.C.	TDI	No Connect	TDO	Yes	If JTAG is not needed, can be left a N.C.
181	N.C.	TRsT*	No Connect	TRsT*	Yes	If JTAG is not needed, can be left a N.C.
182	N.C.	ТСК	No Connect	ТСК	Yes	If JTAG is not needed, can be left a N.C.
183	N.C.	TMS	No Connect	TMS	Yes	If JTAG is not needed, can be left a N.C.
184	N.C.	TDO	No Connect	TDIO	Yes	If JTAG is not needed, can be left a N.C.

Table 9 RC64575 Socket Compatibility to RC64475 & RC4650

### **Absolute Maximum Ratings**

**Note:** Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Symbol	Rating	Commercial (2.5V±5%)	Industrial (2.5V±5%)	Unit
V <sub>TERM</sub>	Terminal Voltage with respect to GND	-0.5 <sup>1</sup> to +4.0	-0.5 <sup>1</sup> to +4.0	V
Т <sub>С</sub>	Operating Temperature (case)	0 to +85	-40 to +85	°C
T <sub>BIAS</sub> <sup>2</sup>	Case Temperature Under Bias	-55 to +125	–55 to +125	°C
T <sub>STG</sub>	Storage Temperature	-55 to +125	–55 to +125	°C
I <sub>IN</sub>	DC Input Current	20 <sup>3</sup>	20 <sup>3</sup>	mA
I <sub>OUT</sub>	DC Output Current	50 <sup>4</sup>	50 <sup>4</sup>	mA

<sup>1</sup> V<sub>In</sub> minimum = -2.0V for pulse width less than 15ns. For 3.3V tolerant input, V<sub>In</sub> maximum is 3.8V.

<sup>2.</sup> Case temperature when device is powered up but not operating.

 $^{3.}$  When V\_{IN} < 0V or V\_{IN} > V\_{CC}.

<sup>4.</sup> Not more than one output should be shorted at a time. Duration of the short should not exceed 30 seconds.

### **Recommended Operation Temperature and Supply Voltage**

Grade	Temperature	GND	RC64574/575	
			Vcc	
Commercial	0°C to +85°C (Case)	0V	2.5V±5%	
Industrial	-40°C to + 85°C (Case)	0V	2.5V±5%	

### **DC Electrical Characteristics**

Commercial Temperature Range—RC64574/575

 $(T_{case} = 0^{\circ}C \text{ to } +85^{\circ}C \text{ Commercial}, T_{case} = -40^{\circ}C \text{ to } +85^{\circ}C \text{ Industrial}, V_{cc} = 2.5V \pm 5\%)$ 

Parameter	RC64574/RC64575 200MHz			4/RC64575 DMHz	Conditions	
	Min	Max	Min	Max		
V <sub>OL</sub>	—	0.1V	—	0.1V	IOUT = 20uA	
V <sub>OH</sub>	V <sub>cc</sub> - 0.1V	_	V <sub>cc</sub> - 0.1V	_		
V <sub>OL</sub>	_	0.4V	_	0.4V	IOUT = 4mA	
V <sub>OH</sub>	2.0V	-	2.0V	_		
V <sub>IL</sub>	-0.5V	0.2V <sub>cc</sub>	-0.5V	0.2V <sub>cc</sub>	—	
V <sub>IH</sub>	0.7 V <sub>cc</sub>	3.8V	0.7 V <sub>cc</sub>	3.8V	—	
I <sub>IN</sub>	—	±10uA	-	±10uA	$0 \le VIN \le VCC$	
C <sub>IN</sub>	_	10pF	—	10pF	_	

Parameter		RC64574/RC64575 200MHz		/RC64575 MHz	Conditions	
	Min	Max	Min	Max		
C <sub>IO</sub>	_	10pF	—	10pF	—	
C <sub>clk</sub>	_	10pF	_	10pF		
I/O <sub>LEAK</sub>	_	20uA	_	20uA	Input/Output Leakage	

#### **Power Consumption**—RC64574

Note: The following table assumes as 4:1 pipeline to bus clock ratio.

Der		RC64574 200MHz		RC64574	250MHz	Conditions
Par	ameter	Typical <sup>1</sup>	Max	Typical <sup>1</sup>	Max	Conditions
I <sub>CC</sub>	stand-by	_	60 mA <sup>2</sup>	—	60 mA <sup>2</sup>	$C_L = 0 p F^3$
		_	120 mA <sup>2</sup>	—	120 mA <sup>2</sup>	C <sub>L</sub> = 50pF
	active	470 mA <sup>2</sup>	550 mA <sup>2</sup>	550 mA <sup>2</sup>	680 mA <sup>2</sup>	C <sub>L</sub> = 0pF No SysAd activity <sup>3</sup> Vcc = 2.63V
		550mA <sup>2</sup>	650 mA <sup>2</sup>	650 mA <sup>2</sup>	800 mA <sup>2</sup>	$C_L = 50 pF$ R4x00 compatible writes, $T_C = 25^{\circ}C$ Vcc = 2.63V
		600 mA <sup>2</sup>	715 mA <sup>4</sup>	715 mA <sup>2</sup>	880 mA <sup>4</sup>	$C_L = 50 pF$ Pipelined writes or write re-issue, $T_C = 25^{\circ}C^3$ Vcc = 2.63V

<sup>1.</sup> Typical integer instruction mix and cache miss rates.

<sup>2.</sup> These are not tested. They are the results of engineering analysis and are provided for reference only.

<sup>3.</sup> Guaranteed by design.

<sup>4.</sup> These are the specifications IDT tests to insure compliance.

#### **RC64574 Power Curves**

The following two graphs contain power curves that show power consumption at various bus frequencies. Power consumption is based on the values for R4x00 compatible write mode, shown in the table above.

Note: Only pipeline frequencies that are integer multiples (2x, 3x, etc.) of bus frequencies are supported.

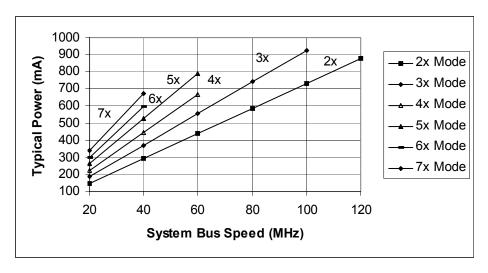


Figure 2 Typical Power Usage - RC64574

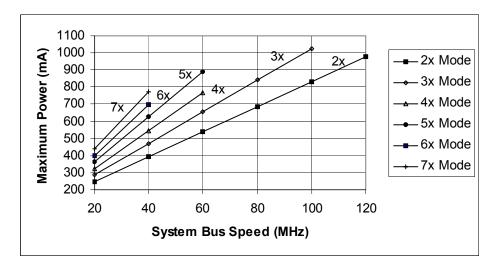


Figure 3 Maximum Power Usage - RC64574

#### **Power Consumption**—RC64575

	<b>4</b>	RC64575 200MHz		RC64575	5 250MHz	0
Par	ameter	Typical <sup>1</sup>	Max	Typical <sup>1</sup>	Мах	Conditions
I <sub>CC</sub>	stand-by	—	60 mA <sup>2</sup>	-	60 mA <sup>2</sup>	$C_L = 0 p F^3$
		—	120 m <sup>2</sup> A	-	120 m <sup>2</sup> A	C <sub>L</sub> = 50pF
	active, 64-bit bus	510 mA <sup>2</sup>	680 mA <sup>2</sup>	600 mA <sup>2</sup>	810 mA <sup>2</sup>	$C_L = 0pF$ No SysAd activity <sup>3</sup> Vcc = 2.63V
	option <sup>4</sup>	600 mA <sup>2</sup>	800 mA <sup>2</sup>	700 mA <sup>2</sup>	950 mA <sup>2</sup>	$C_{L} = 50 pF$ R4x00 compatible writes, $T_{C} = 25^{\circ}C$ Vcc = 2.63V
		660 mA <sup>2</sup>	880 mA <sup>5</sup>	770 mA <sup>2</sup>	1050 mA <sup>5</sup>	$C_{L} = 50 \text{pF}$ Pipelined writes or write re-issue, $T_{C} = 25^{\circ}\text{C}^{3}$ Vcc = 2.63V

Note: The following table assumes a 4:1 pipeline to bus clock ratio.

<sup>1</sup> Typical integer instruction mix and cache miss rates.

<sup>2.</sup> These are not tested. They are the results of engineering analysis and are provided for reference only.

<sup>3.</sup> Guaranteed by design.

<sup>4.</sup> In 32-bit bus option, use RC64574 power consumption values.

<sup>5.</sup> These are the specifications IDT tests to insure compliance.

#### **RC64575 Power Curves**

The following two graphs contain power curves that show power consumption at various bus frequencies. Power consumption is based on the values for R4x00 compatible write mode, shown in the table above.

Note: Only pipeline frequencies that are integer multiples (2x, 3x, etc.) of bus frequencies are supported.

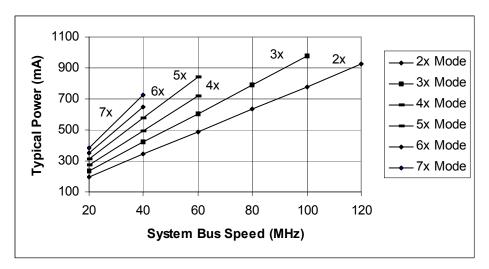


Figure 4 Typical Power Usage - RC64575

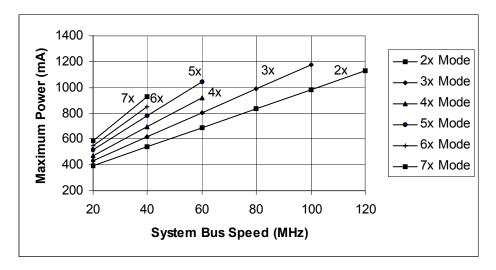
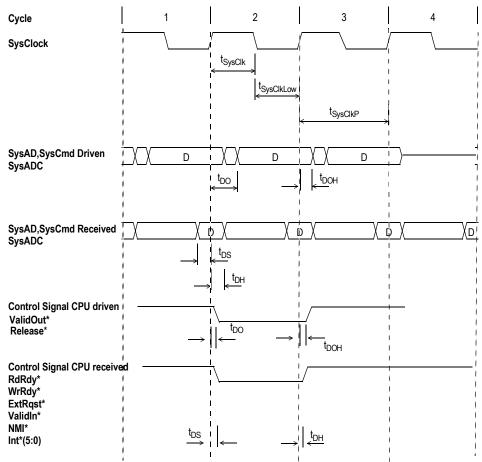


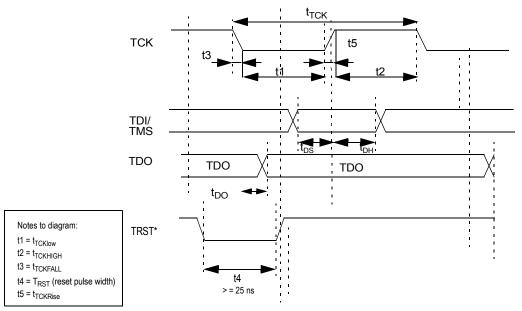
Figure 5 Maximum Power Usage - RC64575

## Timing Characteristics—RC64574/RC64575



\* = active low signal







## **System Interface Parameters**

Parameter	Symbol	Test Conditions	RC64574/ RC64575 200MHz		RC64574/ RC64575 250MHz		Units
			Min	Max	Min	Max	
Data Output	t <sub>DO</sub> = Max	mode <sub>1413</sub> = 10 (Fastest)	—	5	—	4.3	ns
		mode <sub>1413</sub> = 11 (85%)	_	6	_	4.5	ns
		mode <sub>1413</sub> = 00 (66%)	—	7	—	5	ns
		mode <sub>1413</sub> = 01 (Slowest)	—	8	-	5	ns
Data Output Hold	t <sub>DOH</sub> 1	mode <sub>1413</sub> = 10	0	—	0	-	ns
		mode <sub>1413</sub> = 11	0	—	0	—	ns
		mode <sub>1413</sub> = 00	0	—	0	—	ns
		mode <sub>1413</sub> = 01	0	—	0	-	ns
Dete land	t <sub>DS</sub>	t <sub>rise</sub> = 3ns	2	-	2	-	ns
Data Input	t <sub>DH</sub>	t <sub>fall</sub> = 3ns	1.0	—	1.0	—	ns

<sup>1.</sup> 50 pf loading on external output signals

## **Boot-time Interface Parameters**

Parameter	Symbol	RC64574/ RC64575 Test Conditions 200MHz		RC64574/ RC64575 250MHz		Conditions	
			Min	Max	Min	Max	
Mode Data Setup	t <sub>DS</sub>	—	4	—	4	—	SysClock Cycle
Mode Data Hold	t <sub>DH</sub>	_	0	—	0	_	SysClock Cycle

### **AC Electrical Characteristics**

(T<sub>case</sub> = 0°C to +85°C Commercial, T<sub>case</sub> = -40°C to +85°C Industrial, V<sub>cc</sub> = 2.5V± 5%)

#### Clock Parameters—RC64574/575

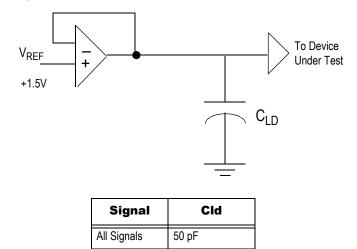
Parameter	arameter Symbol Test Conditions		RC64574/RC64575 200MHz		RC6457 25	Units	
			Min	Max	Min	Max	
Pipeline Clock Frequency	PCLk	—	100	200	100	250	MHz
System Clock HIGH	t <sub>SCHIGH</sub>	Transition ≤ 3ns	3	-	3	-	ns
System Clock LOW	t <sub>SCLOW</sub>	Transition ≤ 3ns	3	-	3	-	ns
System Clock Frequency	_	—	33	100	33	125	MHz
System Clock Period	t <sub>SCP</sub>	—	10	30	8	30	ns
System Clock Jitter	t <sub>JITTER</sub>	—	_	<u>+</u> 250	-	<u>+</u> 250	ps
System Clock Rise Time <sup>1</sup>	t <sub>SCRise</sub>	—	-	2	-	2	ns
System Clock Fall Time <sup>1</sup>	t <sub>SCFall</sub>	—	—	2	-	2	ns
ModeClock Period	t <sub>ModeCKP</sub>	—	_	256 t <sub>SCP</sub>	-	256 t <sub>SCP</sub>	ns
JTAG Clock Input Period	t <sub>TCK</sub>	—	—	100	-	100	ns
JTAG Clock HIGH	t <sub>TCKHIGH</sub>	—	-	40	-	40	ns
JTAG Clock Low	t <sub>TCKLOW</sub>	—	_	40	-	40	ns
JTAG Clock Rise Time	t <sub>TCKRise</sub>	—	—	5	-	5	ns
JTAG Clock Fall Time	t <sub>TCKFall</sub>	—	—	5	-	5	ns

<sup>1</sup> Rise and Fall times are measured between 10% and 90%

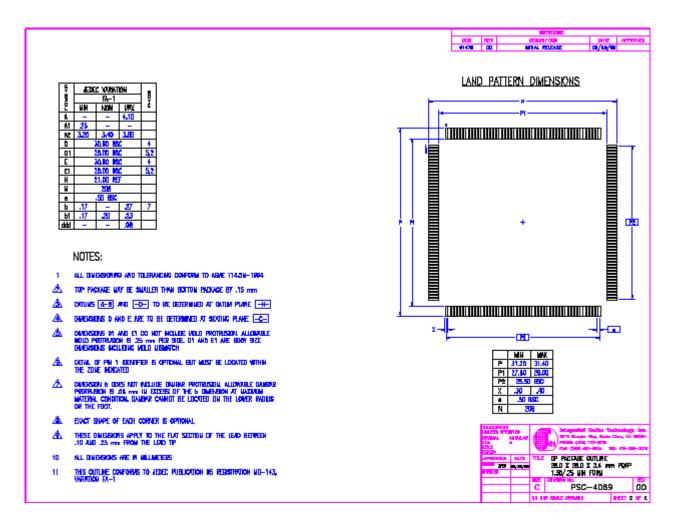
### **Capacitive Load Deration—RC64574/575**

Parameter	Symbol	Test			250MHz		Units
i araneter	Cymbol	Conditions	Min	Max	Min	Max	Units
Load Derate	C <sub>LD</sub>	_	—	2	-	2	ns/25pF

### **Output Loading for AC Testing**

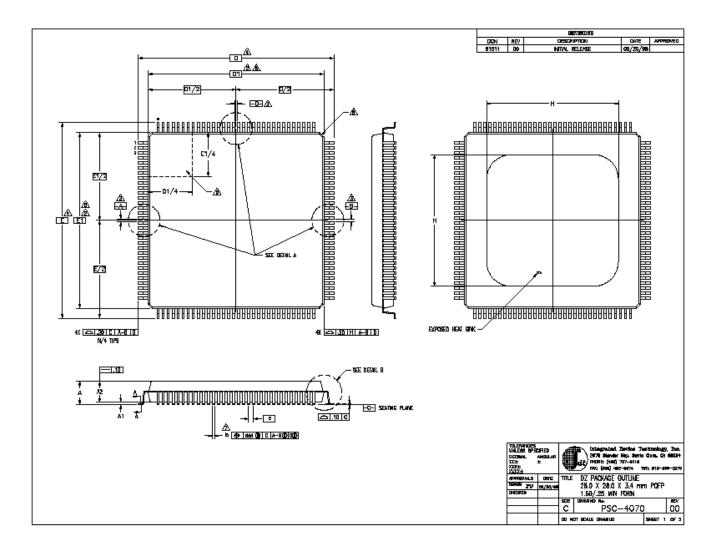


### RC64575 208-pin Package Diagram (page2)

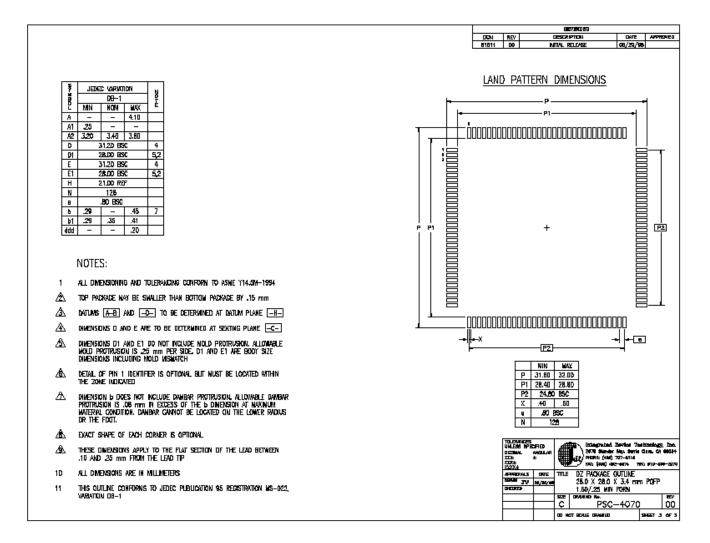


## RC64574 128-pin Package Diagram (page 1 of 3)

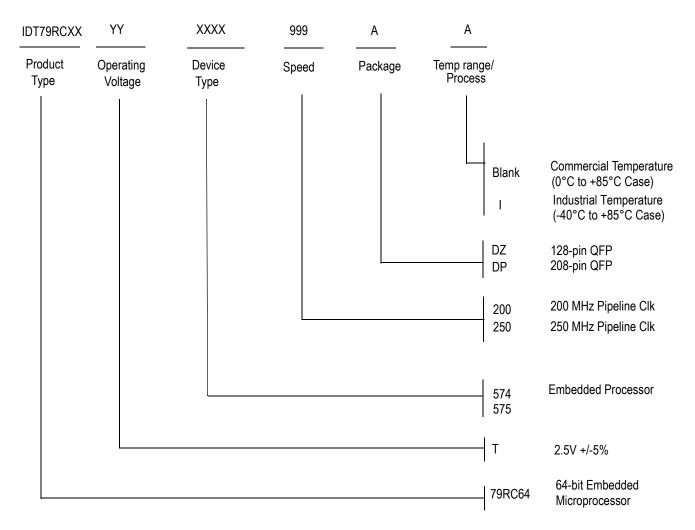
The RC64574 is available in a 128-pin QFP package.



#### RC64574 128-pin Package Diagram (page 3 of 3)



## **Ordering Information**



### **Valid Combinations**

IDT79RC64T574 - 200, 250, DZ	128-pin QFP package, Commercial Temperature
IDT79RC64T575 - 200, 250, DP	208-pin QFP package, Commercial Temperature
IDT79RC64T574 - 200, 250, DZI	128-pin QFP package, Industrial Temperature
IDT79RC64T575 - 200, 250, DPI	08-pin QFP package, Industrial Temperature



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